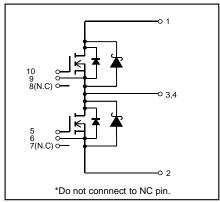
Application

- · Motor drive
- · Inverter, Converter
- · Photovoltaics, wind power generation.
- · Induction heating equipment.

Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

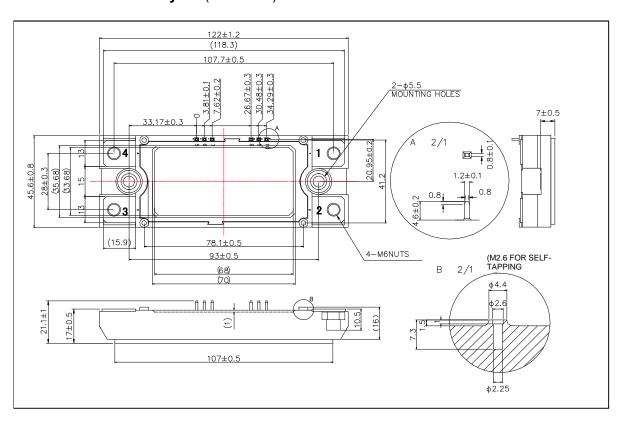
●Circuit diagram



Construction

This product is a half bridge module consisting of SiC-DMOS and SiC SBD from ROHM.

●Dimensions & Pin layout (Unit : mm)

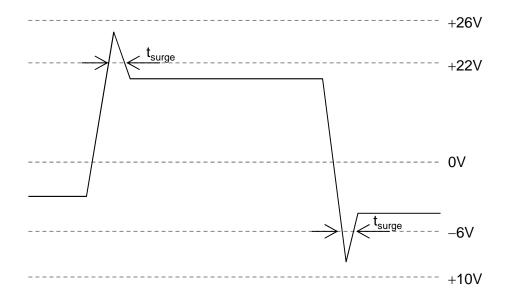


● Absolute maximum ratings (Tj = 25°C)

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V_{DSS}	G-S short	1200		
Gate-source voltage(+)	V	D-S short	22	V	
Gate-source voltage(-)	V_{GSS}	D-3 SHOIL	-6		
G - S voltage (t _{surge} <300ns)	$V_{GSSsurge}$	D-S short	-10 to 26		
Drain current *1	I _D	DC(T _c =60°C)	80	A	
	I _{DRM}	Pulse (T _c =60°C) 1ms *2	160		
Source current *1	Is	$DC(T_c = 60^{\circ}C) V_{GS}=18V$	80		
	I _{SRM}	Pulse (T _c =60°C) 1ms V _{GS} =18V	160		
Total power disspation *3	Ptot	T _c =25°C	600	W	
Max junction temperature	T _{jmax}		175		
Junction temperature	T_jop		-40 to150	°C	
Storage temperature	T _{stg}		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
Mounting torque	_	Main Terminals : M6 screw	4.5	N·m	
		Mounting to heat shink: M5 screw	3.5		

^(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

Example of acceptable Vgs waveform



^(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed T_{jmax}.

^(*3) T_i is less than 175°C

●Electrical characteristics (Tj=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
On-state static Drain-Source Voltage	V _{DS(on)}	I _D =80A, V _{GS} =18V	T _j =25°C	_	2.8	3.5	V
			T _j =125°C	_	4.2	_	
			T _j =150°C	1	4.8	5.5	
Drain cutoff current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V		_	١	1.2	mA
Source-drain voltage	V_{SD}	V _{GS} =0V, I _S =80A	T _j =25°C	1	1.7	2.0	V
			T _j =125°C	-	2.1	_	
			T _j =150°C	-	2.3	3.3	
		V _{GS} =18V, I _S =80A	T _j =25°C	ı	1.4	_	
			T _j =125°C	1	1.7	_	
			T _j =150°C	-	1.8	_	
Gate-source threshold voltage	$V_{GS(th)}$	V _{DS} =10V, I _D =13.2mA		1.6	_	4	V
Gate-source leak current	I _{GSS}	V_{GS} =22V, V_{DS} =0V		_	_	0.5	μА
		$V_{GS} = -6V, V_{DS} = 0V$		-0.5	_	_	
Switching characteristics	t _{d(on)}	$V_{GS(on)}$ =18V, $V_{GS(off)}$ =0V V_{DS} =600V		_	20	_	ns
	t _r			_	30	_	
	t _{rr}	I _D =80A		_	35	_	
	$t_{d(off)}$	R_G =0.82 Ω inductive load		-	80	_	
	t _f			ı	40	_	
Input capacitance	Ciss	V_{DS} =10V, V_{GS} =0V, f=1MHz		-	8	_	nF
Gate Registance	R_{Gint}	T _j =25°C			3.0	_	Ω
Stray Inductance	Ls				25	_	nH
Creepage distance	ı	Terminal to heat sink			11.5	_	mm
		Terminal to terminal			19.0	_	mm
Clearance distance	1	Terminal to heat sink			9.5	_	mm
		Terminal to terminal			13.0	_	mm
Junction-to-case thermal	Date U=C.	DMOSFET (1/2 module) *4		1	_	0.25	°C/W
resistance		SBD (1/2 module) *4		1	_	0.32	
Case-to-heat sink	R _{th} (c-f)	Case to heat sink, per 1		0.035	_		
Thermal resistance	Tth(U-1)	Thermal grease applied *5			0.035		

- (*4) Measurement of Tc is to be done at the point just under the chip.
- (*5) Typical value is measured by using thermally conductive grease of λ=0.9W/(m K).
- (*6) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (*7) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>

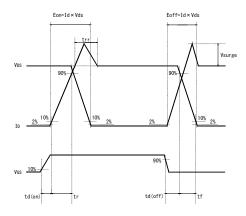


Fig.1 Typical Output Characteristics [T_j=25°C] V_{GS}=16V V_{GS}=18V 120 Drain Current: I_D [A] V_{GS}=20V V_{GS}=14V 80 V_{GS}=12V 40 V_{GS}=10V 0 0 2 6 Drain-Source Voltage : V_{DS} [V]

8 V_{GS}=18V 7 Drain-Source Voltage: V_{DS} [V] 6 T_j=125°C 5 T_i=150°C 4 T_i=25°C 3 2 1 0 40 80 120 160 Drain Current : I_D [A]

Fig.2 Drain-Source Voltage vs. Drain Current

Fig.3 Drain-Source Voltage vs. Gate-Source Voltage [T_i=25°C] 8 T_i=25°C 7 Drain-Source Voltage: V_{DS} [V] 6 5 4 3 I_D=80A 2 $I_D = 60A$ $I_D=40A$ 1 $I_D=20A$ 0 14 16 18 20 22 24 12 Gate-Source Voltage : V_{GS} [V]

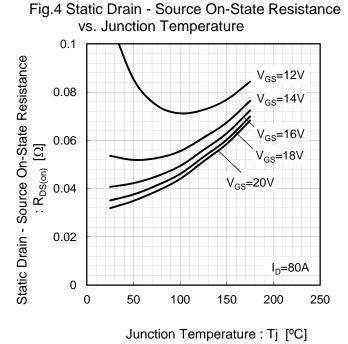




Fig.5 Forward characteristic of Diode

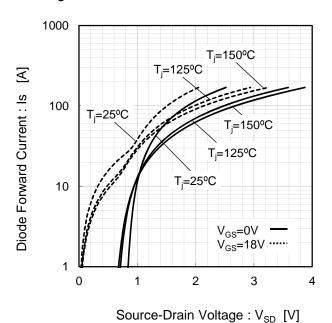
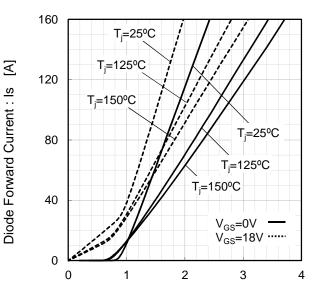
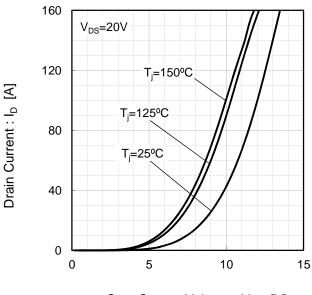


Fig.6 Forward characteristic of Diode



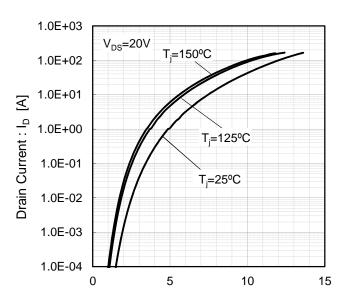
Source-Drain Voltage: V_{SD} [V]

Fig.7 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage: V_{GS} [V]

Fig.9 Switching Characteristics [T_i=25°C]

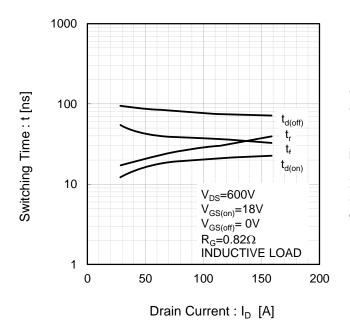
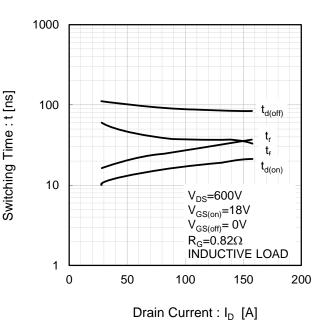


Fig.10 Switching Characteristics [T_i=125°C]



Switching Loss [mJ]

Fig.11 Switching Characteristics [T_i=150°C]

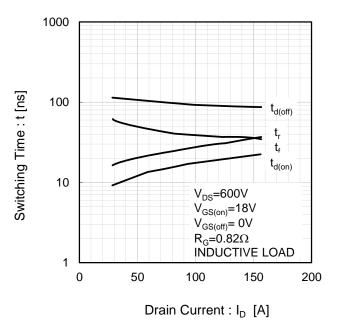
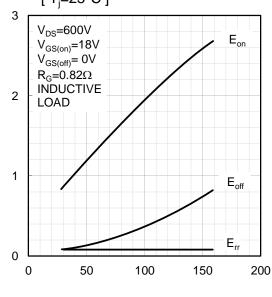


Fig.12 Switching Loss vs. Drain Current [$T_i=25^{\circ}C$]



Drain Current : I_D [A]

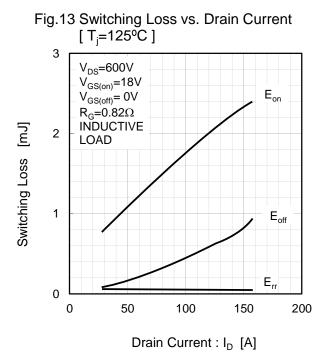
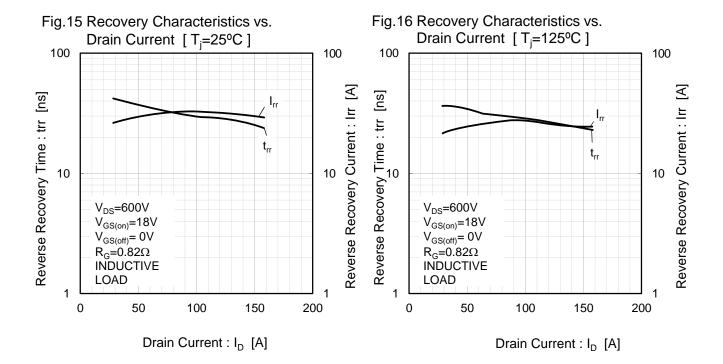


Fig.14 Switching Loss vs. Drain Current $[T_i=150^{\circ}C]$ 3 V_{DS}=600V $V_{GS(on)} = 18V$ E_{on} $V_{GS(off)} = 0V$ $R_G=0.82\Omega$ INDUCTIVE <u>"</u> 2 LOAD Switching Loss $\mathsf{E}_{\mathsf{off}}$ 1 E_{rr} 0 50 100 0 150 200 Drain Current: I_D [A]



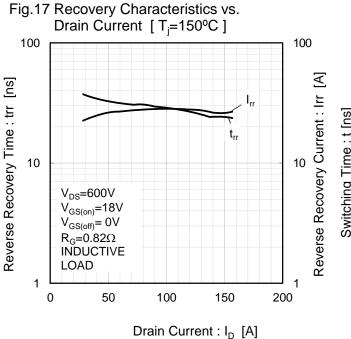
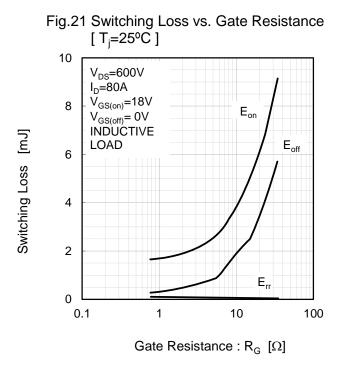


Fig.18 Switching Characteristics vs. Gate Resistance [T_i=25°C] 1000 V_{DS}=600V $t_{d(off)}$ I_D=80A V_{GS(on)}=18V V_{GS(off)}= 0V INDUCTIVE Switching Time:t [ns] LOAD 100 $t_{d(on)}$ 10 0.1 1 10 100 Gate Resistance : R_G [Ω]

Fig.19 Switching Characteristics vs. Gate Resistance [T_i=125°C] 1000 V_{DS}=600V $t_{d(off)}$ $I_D = 80A$ V_{GS(on)}=18V V_{GS(off)}= 0V INDUCTIVE Switching Time: t [ns] LOAD 100 $t_{d(on)}$ 10 0.1 1 10 100 Gate Resistance : R_G [Ω]



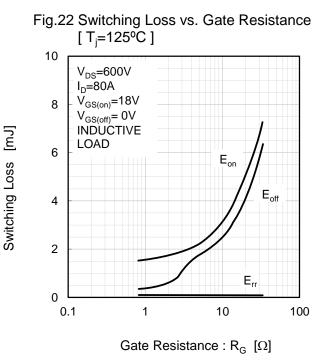
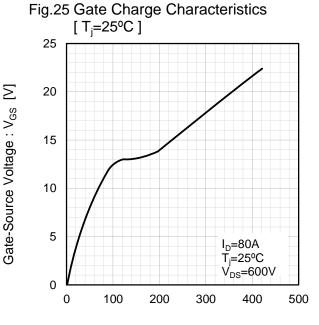


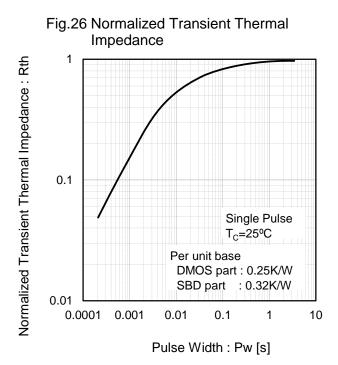
Fig.23 Switching Loss vs. Gate Resistance $[T_i=150^{\circ}C]$ 10 V_{DS}=600V I_D=80A $V_{GS(on)}$ =18V $V_{GS(off)}$ = 0V INDUCTIVE 8 LOAD 6 $\mathsf{E}_{\mathsf{off}}$ 4 2 E_{rr} 0 0.1 1 10 Gate Resistance : R_G [Ω]

Fig.24 Typical Capacitance vs. Drain-Source Voltage 1.E-07 Ciss 1.E-08 Capasitance: C [nF] Coss 1.E-09 1.E-10 Crss T_i=25°C V_{GS}=0V 200kHz 1.E-11 0.01 0.1 10 100 1000

Drain-Source Voltage: V_{DS} [V]



Total Gate charge : Qg [nC]



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